



Product Change Notification

Change Notification #: 118488-00
Change Title: Select Intel® SSD D7-P5500 Series, and Intel® SSD D7-P5608 Series for Oracle*
PCN 118488-00, Product Material, Add alternate DRAM to ADP BOM
Date of Publication: September 17, 2021

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material	December 17, 2021
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Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have the following changes.

1. Current DRAM IPN# J87850-001 EOL-ing (Nanya) and changing to new IPN# J87850-002 (Nanya), affect ADP ME SFF 3.2T, ADP SE SFF 3.8T, ADP AICx8 6.4T.
2. Current DRAM IPN# K47704-001 EOL-ing (Samsung) and changing to new IPN# K92222-002 (Hynix), affected ADP ME 6.4T and ADP SE 7.6T

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

*Other names and brands may be claimed as the property of others.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	TA	SA	PBA
Intel® SSD D7-P5608 Series (6.4TB, 1/2 Height PCIe 4.0 x8, 3D3, TLC) Oracle Single Pack	SSDPFCKE064T9S1	999RNX	K76458-000	K76456-002	K82643-075
Intel® SSD D7-P5500 Series (7.68TB, 2.5in PCIe 4.0 x4, 3D3, TLC) Oracle Single Pack	SSDPF2KX076T9SP	99A0HH	K90145-100	K90167-101	K83463-103
Intel® SSD D7-P5500 Series (3.84TB, 2.5in PCIe 4.0 x4, 3D3, TLC) Oracle Single Pack	SSDPF2KX038T9S1	99A5JH	M11237-100	M11291-100	K83461-103
Intel® SSD D7-P5608 Series (6.4TB, 1/2 Height PCIe 4.0 x8, 3D3, TLC) Oracle 10 Pack	SSDPFCKE064T9SP	99A5JJ	M11247-000	K76456-002	K82643-075
Intel® SSD D7-P5500 Series (3.84TB, 2.5in PCIe 4.0 x4, 3D3, TLC) Oracle Single Pack	SSDPF2KX038T9SP	99AG82	M34487-100	M11291-100	K83461-103
Intel® SSD D7-P5500 Series (7.68TB, 2.5in PCIe 4.0 x4, 3D3, TLC) Oracle Single Pack	SSDPF2KX076T9S1	99AG83	M34490-100	K90167-101	K83463-103

PCN Revision History:

Date of Revision:
September 17, 2021

Revision Number:
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Reason:
Originally Published PCN



Product Change Notification

118488-00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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